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FDMC7200

Dual N-Channel PowerTrench[®] MOSFET 30 V, 12 m Ω and 23.5 m Ω

Features

- Q1: N-Channel
- Max $r_{DS(on)}$ = 23.5 m Ω at V_{GS} = 10 V, I_D = 6 A
- Max $r_{DS(on)}$ = 38 m Ω at V_{GS} = 4.5 V, I_D = 5 A

Q2: N-Channel

- Max $r_{DS(on)}$ = 12 m Ω at V_{GS} = 10 V, I_D = 8 A
- Max $r_{DS(on)}$ = 18 m Ω at V_{GS} = 4.5 V, I_D = 7 A
- RoHS Compliant

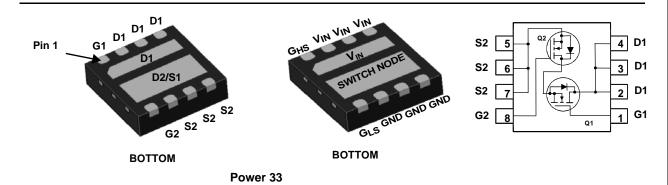


General Description

This device includes two specialized N-Channel MOSFETs in a dual Power33 (3mm x 3mm MLP) package. The switch node has been internally connected to enable easy placement and routing of synchronous buck converters. The control MOSFET (Q1) and synchronous MOSFET (Q2) have been designed to provide optimal power efficiency.

Applications

- Mobile Computing
- Mobile Internet Devices
- General Purpose Point of Load



MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted

| Symbol | Parameter | | Q1 | Q2 | Units |
|-----------------------------------|--|------------------------|-------------------|-------------------|-------|
| V _{DS} | Drain to Source Voltage | | 30 | 30 | V |
| V _{GS} | Gate to Source Voltage | (Note 3) | ±20 | ±20 | V |
| | Drain Current - Continuous (Package limited) | T _C = 25 °C | 8 | 8 | |
| | - Continuous (Silicon limited) | T _C = 25 °C | 20 | 40 | ^ |
| D | - Continuous | T _A = 25 °C | 6 ^{1a} | 8 ^{1b} | A |
| | - Pulsed | | 40 | 40 | _ |
| D | Power Dissipation | T _A = 25 °C | 1.9 ^{1a} | 2.2 ^{1b} | w |
| P _D | Power Dissipation | T _A = 25 °C | 0.7 ^{1c} | 0.9 ^{1d} | vv |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | | -55 to | +150 | °C |

Thermal Characteristics

| R_{\thetaJA} | Thermal Resistance, Junction to Ambient | 65 ^{1a} | 55 ^{1b} | |
|-----------------------|---|-------------------|-------------------|------|
| R_{\thetaJA} | Thermal Resistance, Junction to Ambient | 180 ^{1c} | 145 ^{1d} | °C/W |
| $R_{	extsf{	heta}JC}$ | Thermal Resistance, Junction to Case | 7.5 | 4 | |

Package Marking and Ordering Information

| ſ | Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|---|----------------|----------|----------|-----------|------------|------------|
| | FDMC7200 | FDMC7200 | Power 33 | 13 " | 12 mm | 3000 units |

June 2009

| FDMC7200 [|
|-----------------------|
| Duall |
| N-Channel |
| PowerTrench |
| ו [®] MOSFET |

| Symbol | Parameter | Test Conditions | Туре | Min | Тур | Max | Units |
|--|---|--|----------|------------|----------------|--------------------|----------|
| Off Chara | cteristics | | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | $ I_D = 250 \ \mu A, \ V_{GS} = 0 \ V \\ I_D = 250 \ \mu A, \ V_{GS} = 0 \ V $ | Q1 Q2 | 30 30 | | | V |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$ | Breakdown Voltage Temperature Coefficient | $I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 250 \ \mu$ A, referenced to 25 °C | Q1 Q2 | | 14 14 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 24 V, V_{GS} = 0 V$ $V_{DS} = 24 V, V_{GS} = 0 V$ | Q1 Q2 | | | 1 1 | μA |
| I _{GSS} | Gate to Source Leakage Current | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ | Q1 Q2 | | | 100 100 | nA nA |
| On Chara | cteristics | | | | | | |
| V _{GS(th)} | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_D = 250 \ \mu A$ $V_{GS} = V_{DS}, I_D = 250 \ \mu A$ | Q1 Q2 | 1.0 1.0 | 2.3 2.3 | 3.0 3.0 | V |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate to Source Threshold Voltage Temperature Coefficient | $I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 250 \ \mu$ A, referenced to 25 °C | Q1 Q2 | | -5 -6 | | mV/°C |
| | Static Drain to Source On Resistance | | Q1 | | 19 28 29 | 23.5 38 35.5 | - mΩ |
| r _{DS(on)} | | | Q2 | | 10 13 15 | 12 18 18 | |
| 9 _{FS} | Forward Transconductance | $V_{DD} = 5 V, I_D = 6 A$ $V_{DD} = 5 V, I_D = 8 A$ | Q1 Q2 | | 29 56 | | S |
| Dynamic | Characteristics | | | | | | |
| C _{iss} | Input Capacitance | | Q1 Q2 | | 495 1180 | 660 1570 | pF |
| C _{oss} | Output Capacitance | $V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHZ}$ | Q1 Q2 | | 145 330 | 195 440 | pF |
| C _{rss} | Reverse Transfer Capacitance | | Q1 Q2 | | 20 30 | 30 45 | pF |
| R _g | Gate Resistance | | Q1 Q2 | | 1.4 1.4 | | Ω |
| Switching | g Characteristics | | | | | | |
| t _{d(on)} | Turn-On Delay Time | Q1 | Q1 Q2 | | 11 13 | 20 23 | ns |
| t _r | Rise Time | V_{DD} = 15 V, I _D = 1 A, V _{GS} = 10 V, R _{GEN} = 6 Ω | Q1 Q2 | | 3.1 4 | 10 10 | ns |
| t _{d(off)} | Turn-Off Delay Time | | Q1 Q2 | | 35 38 | 56 60 | ns |

Electrical Characteristics T_J = 25 °C unless otherwise noted

Q2 V_{DD} = 15 V, I_D = 1 A, V_{GS} = 10 V, R_{GEN} = 6 Ω Fall Time t_f Q2 6 Q1 7.3 $V_{GS} = 0 V$ to 10 V Q1: Total Gate Charge Q_{g(TOT)} Q2 16 $V_{GS} = 0 V$ to 4.5 V $I_D = 6 A$, Q1 3.1 $Q_{g(TOT)}$ Total Gate Charge 7 Q2 Q1 1.8 Q2: Q_gs Gate to Source Charge Q2 4.1 $V_{DD} = 15 V,$ $I_{D} = 8 A,$ Q1 1 Gate to Drain "Miller" Charge Q_{gd} Q2 1.5

ns

nC

nC

nC

nC

60

10

12

10

22

4.3

10

38

1.3

Q2

Q1

2

| FDM |
|-----------|
| DMC7200 |
| Dual N |
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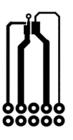
| Symbol | Parameter | Test Conditions | | Туре | Min | Тур | Max | Units |
|-----------------|---------------------------------------|---|--------------------|----------|-----|------------|------------|-------|
| Drain-Sou | urce Diode Characteristics | | | | | | | |
| V _{SD} | Source to Drain Diode Forward Voltage | 00 / 0 | Note 2) Note 2) | Q1 Q2 | | 0.8 0.8 | 1.2 1.2 | V |
| t _{rr} | Reverse Recovery Time | Q1 I _F = 6 A, di/dt = 100 A/s | | Q1 Q2 | | 13 21 | 24 34 | ns |
| Q _{rr} | Reverse Recovery Charge | Q2 I _F = 8 A, di/dt = 100 A/s | | Q1 Q2 | | 2.3 5.6 | 10 12 | nC |

Notes:

1. R_{0JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

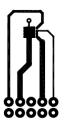


80000



c. 180 °C/W when mounted on a minimum pad of 2 oz copper

a.65 °C/W when mounted on a 1 in $^2\,$ pad of 2 oz copper



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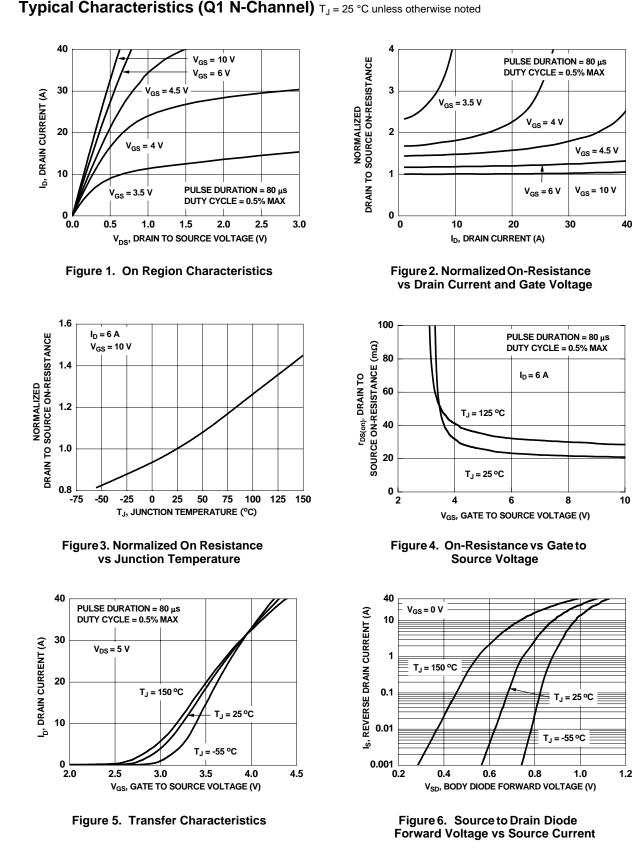
80000

d. 145 °C/W when mounted on a minimum pad of 2 oz copper

b.55 °C/W when mounted on a 1 in² pad of 2 oz copper

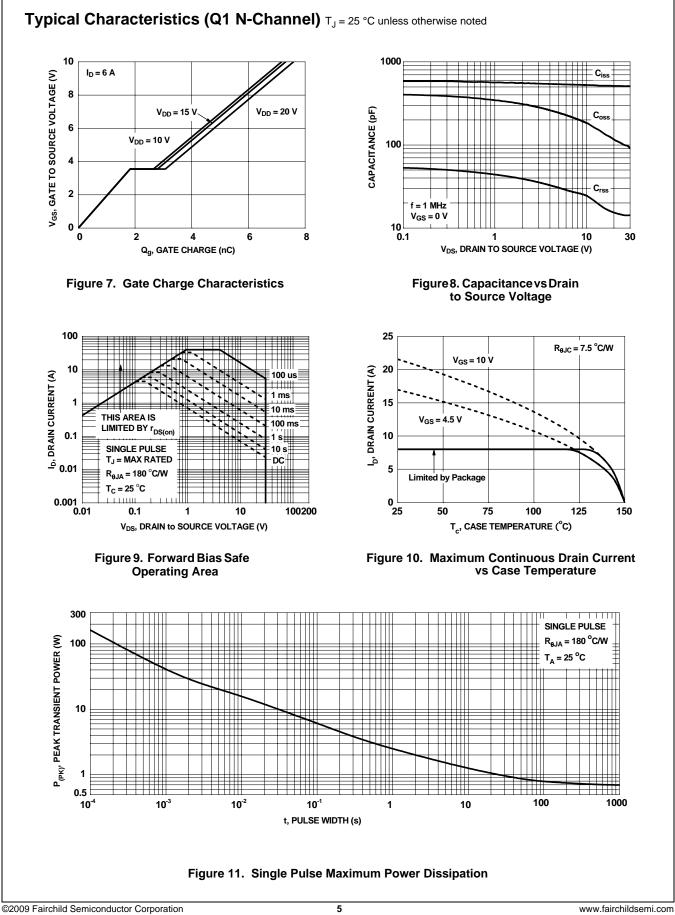
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

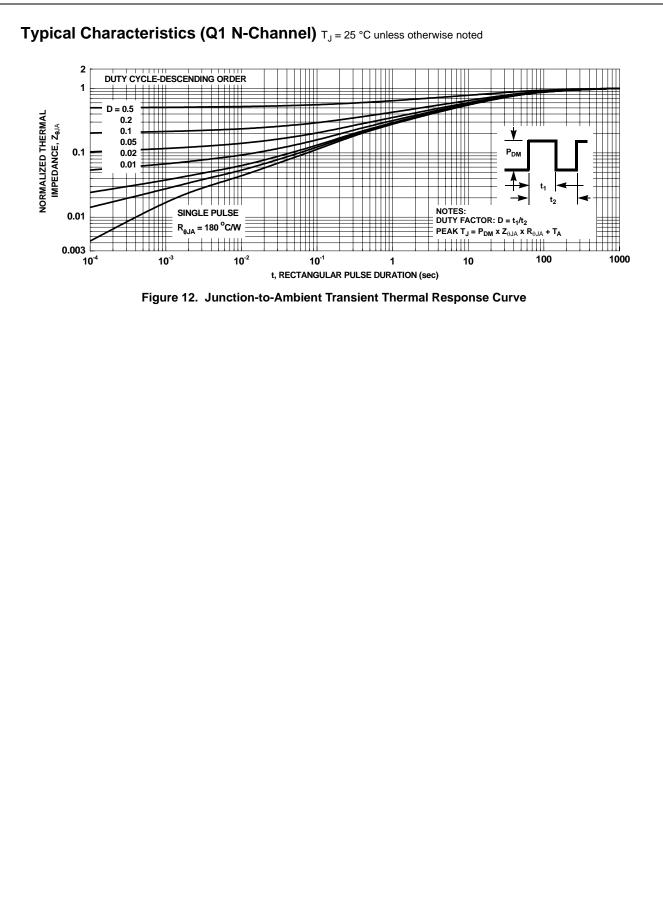
3. As an N-ch device, the negative Vgs rating is for low duty cycle pulse ocurrence only. No continuous rating is implied.

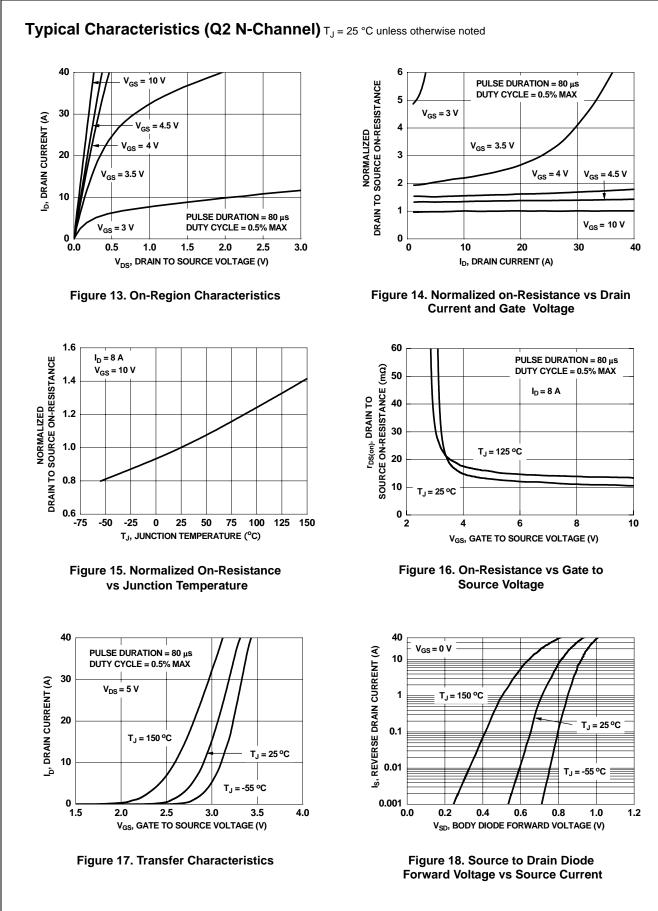


Typical Characteristics (Q1 N-Channel) T_J = 25 °C unless otherwise noted

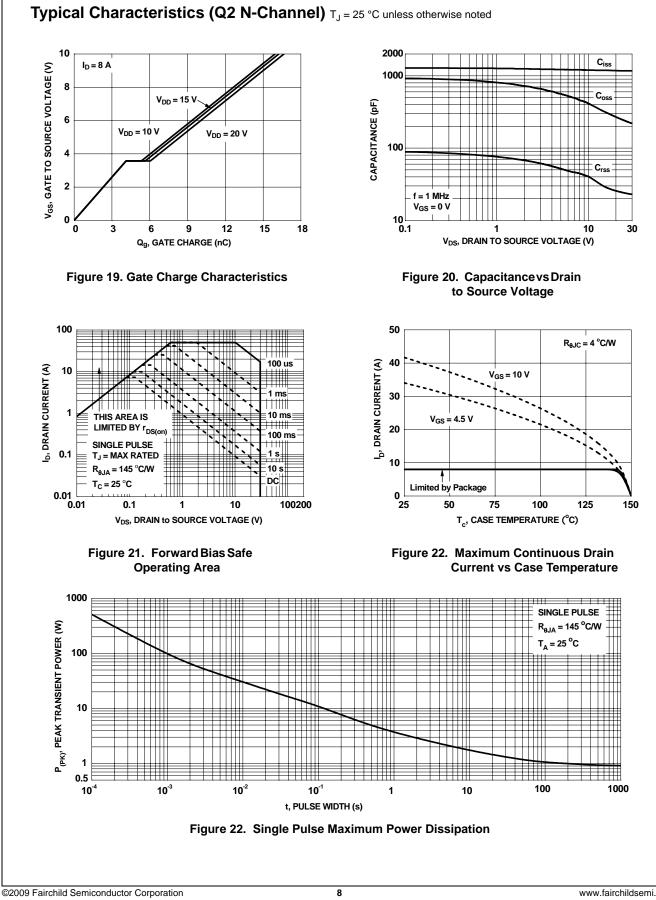




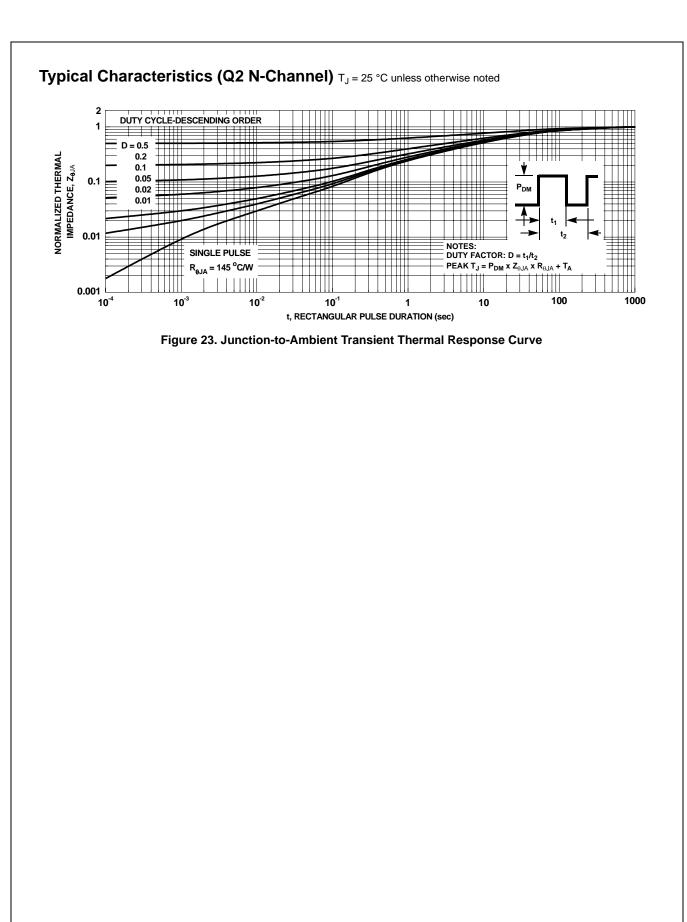


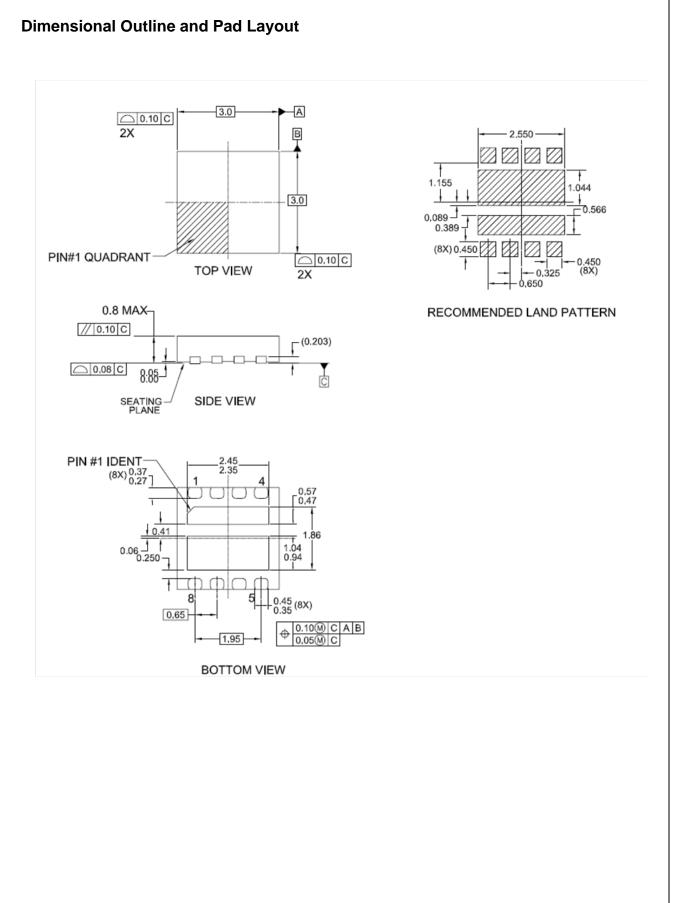














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